MN662740RE Signal Processing LSI for CD Players

Overview

The MN662740RE is a CD signal processing LSI that, on a single chip, combines an optics servo for the CD player (focus, tracking, and traverse servos), digital signal processing (EFM demodulation and error correction), Showing the provide the provided the provide digital servo processing for the spindle motor, digital filter, and D/A converter, so thus covers all signal processing functions from the head's RF amplifier onward.

Features

(Optics servo)

- Focus, tracking, and traverse servos
- Automatic adjustment functions for FO/TR gain, FO/TR offset, and FO/TR balance
- Built-in D/A converter for drive voltage output
- Built-in dropout countermeasures
- Anti-shock functions
- Built-in track cross counter
- Support for both linear motor and screw-based traverse mechanisms
- Support for 3- and 1-beam systems

(Digital signal processing)

- Built-in DSL and PLL
- Frame synchronization detection, holding, and insertion
- Subcode data processing
- CIRC error detection and correction
- Audio data interpolation
- Soft muting
- Digital attenuation (256 levels)
- Software attenuation (256 levels)
- Audio data peak level detection function
- Auto cue detection function
- Digital audio interface (EIAJ format)
- Audio data serial interface for input and output

(Spindle motor servo)

• CLV digital servo

(Audio circuits)

- Digital filter using 8-fold oversampling
- Built-in differential operational amplifier (2nd order

- Built-in playback pitch control function (±13%)
- Guaranteed operation for double-speed playback except for D/A converter output and 4ds mode serial

Block Diagram



Panasonic

Package Dimensions (Unit: mm)

QFS080-P-1414



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